Design Digitaler Schaltkreise

Place and route 2

Asic and Detector Lab - IPE

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Ilias: https://ilias.studium.kit.edu/goto_produktiv_crs_430424.html

Lecture Goal

- Understand the basics of Timing Configuration
- Understand the concept of Clock Synthesis
- See last routing and design completion steps

Timing Setup: MMMC

- Multi-Mode Multi-Corner
- Multi-Mode:
  - All configurations in which the ASIC can run, ex: Test mode, Functional
- Corners: Timing Characterisation of libraries for different conditions:
  - Voltages
  - Temperature
  - Best Case, Worst Case
- Views: Modes + Corners
  - Slow Corners: Fix Setup
  - Fast Corners: Fix Hold

Modes * Corners

Test, Functional, Power save etc…

Best, Worst etc…

views

Timing Setup: On Chip Variation

- For slower technology nodes (<65nm) On-Chip Variation (OCV) become more and more dominant:
  - Two adjacent transistors on the die are different.
  - The smaller the technology, the disparate it gets.
- OCV also affects RC extraction for routing lines
- OCV adds up as an extraction corner
  - Worsens the runtimes
- Setup challenges: Technology specific, not always easy to have correct values to setup the tool with.
- Difficulty for us: very much process-related, we are not process experts
- In an industry context: don't forget about it!

Timing Fixes during implementation

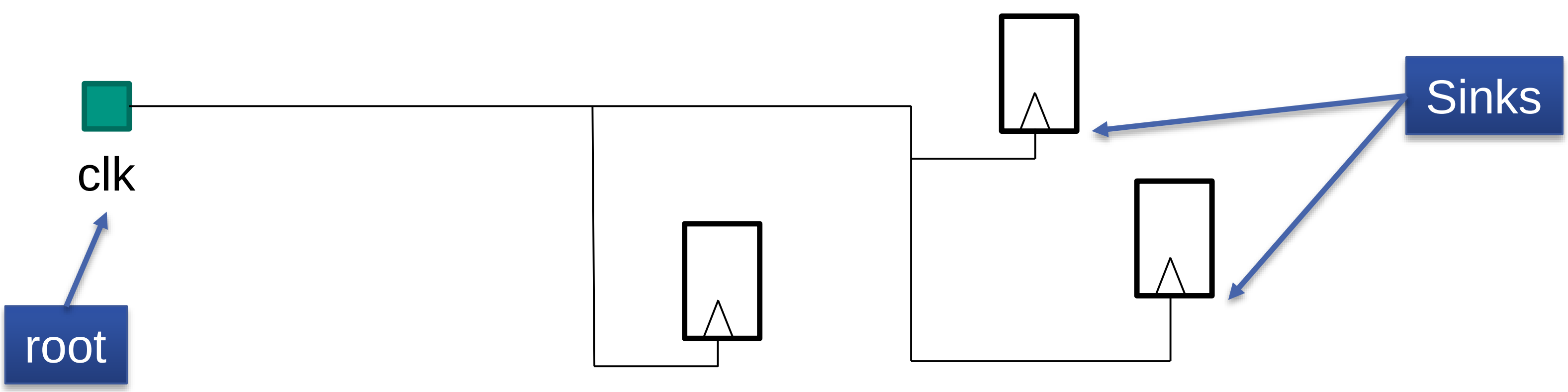
- In Cadence tools, the optDesign command is used to reclaim timing after each phase:
  - Before Clock Tree Synthesis
  - Before Routing
  - After Routing
- Timing Fixes are done for Setup and Hold separately
- Fixes may alter manufacturing rules (DRC)
- DRC may alter timing:
  - Always re-optimise the design along the implementation flow
- Ignore this right now:
  - No Specific pattern:
    - See what he tool does and re-call design optimisation with different options to fix alterations
  - Runtimes go higher, not a good idea for the lab work as well

Where are we?

- Floorplaning is done and set
- Input Outputs are set
- Power structures have been planned
- Standard Cells are placed
- Remains:
  - Distribute the clock
  - Route the design
  - Respect Design Rules for manufacturing
  - Keep timing acceptable
  - Output design data for DRC/LVS and production

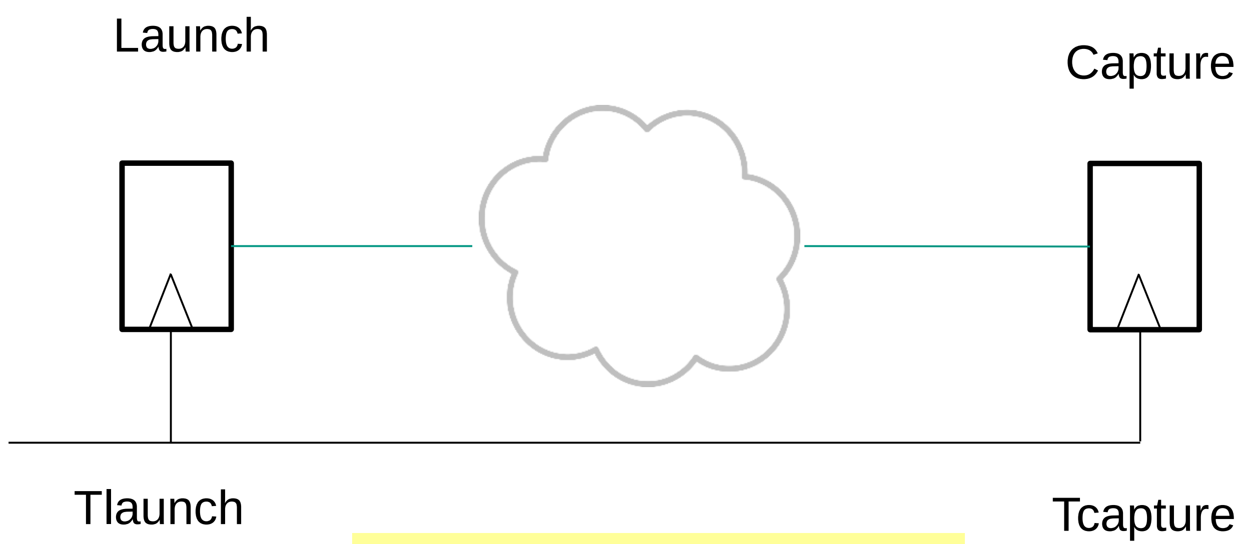
Clock Tree Synthesis (CTS)

- Per-Clock domain:
  - 1 Clock Source
  - Many Sinks
- Goal: Clock available at all flip-flops at the same time
- Clock net is very constraining:
  - Toggles a lot: Power consumption
  - Can toggle fast: Signal Integrity aggressor
  - Long wires: Difficult to drive and balance



CTS: Clock Skew

- Clock arrives at Launch and Capture ports
- Positive and Negative Skew are possible



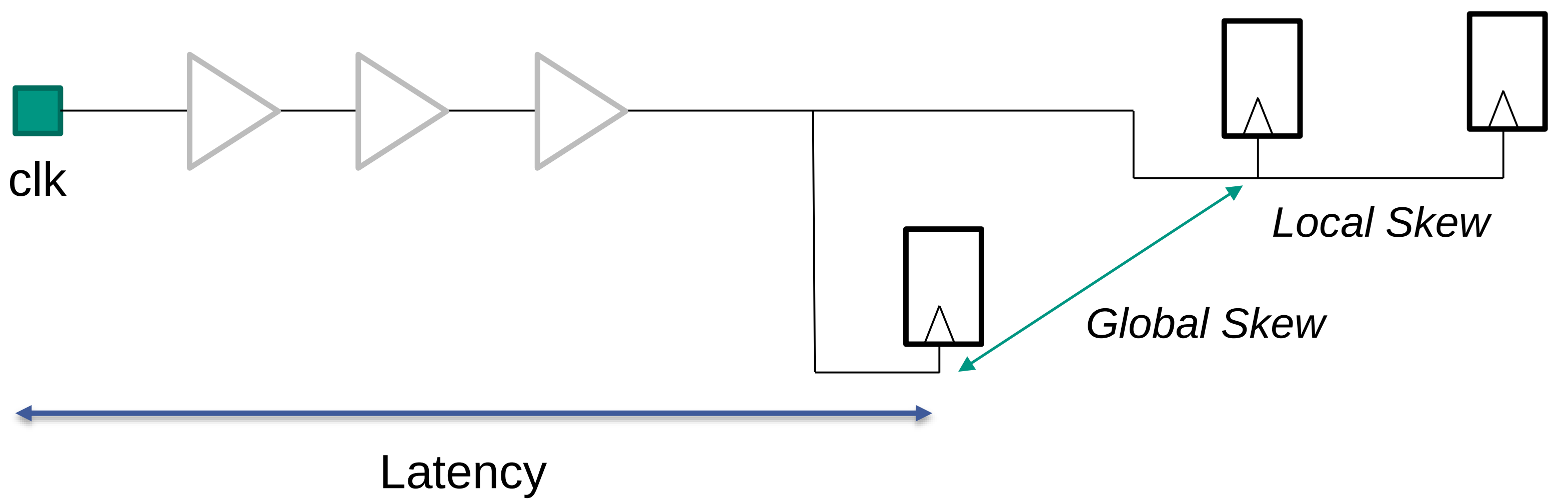
Skew = Tcapture - Tlaunch

<u>Positive: Leaves time for setup</u>

<u>Negative: Removes time for setup</u>

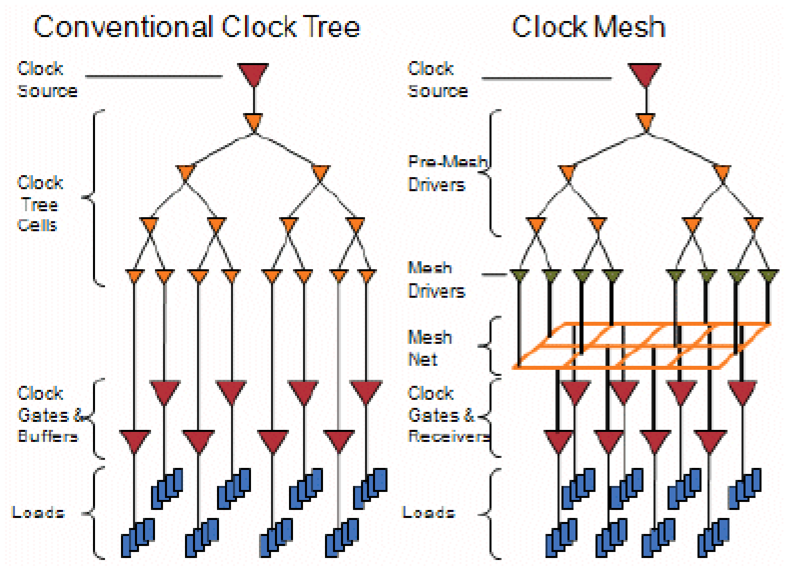
CTS: Semantics

- Latency is used to describe the time to reach the sinks
- Skew is defined in: Local and Global categories
  - Local for related flip-flops
  - Global for unrelated flip-flops



CTS: Achieving Zero-Skew

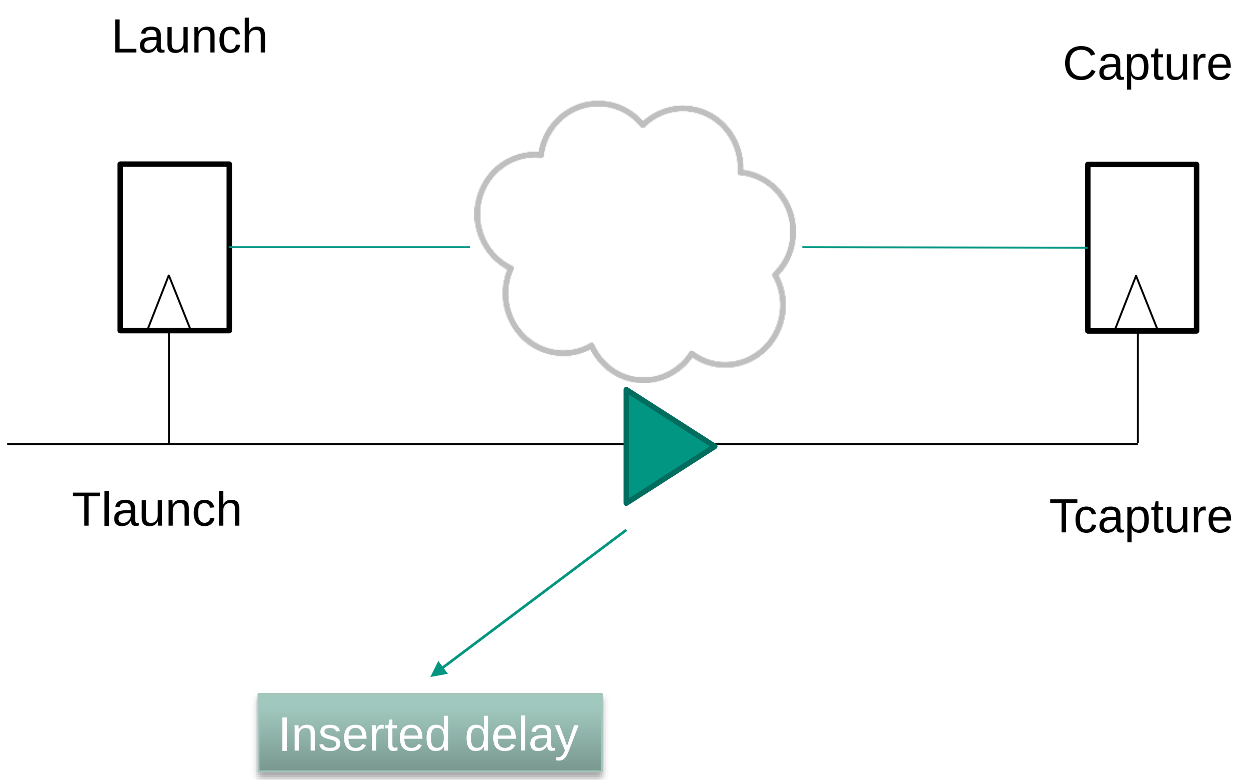
- There are two types of clock routing:
  - Clock Tree: The commonly used path
  - Clock mesh: A grid for the clock
    - Better Skew, but higher resource usage
- Main Goal: No skew
  - All flip-flops get the clock at the same time
- Zero-Skew clock tree algorithms are available and researched
  - Not the focus here
- At Lower technology nodes:
  - On-Chip Variation influence increases (OCV)
  - Clock meshes seem to have a better tolerance to OCV
- Rule: Understand what the tool can do, and the advantages for the specific technology and chip size



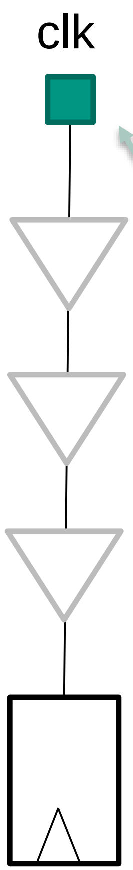
http://www.design-reuse.com/articles/21019/clock-mesh-benefits-analysis.html

CTS: Useful Skew example

- Feature example: The tool can try to use positive/negative skew to improve setup or hold timing
- Use with precaution, first try to meet timing with no fancy feature



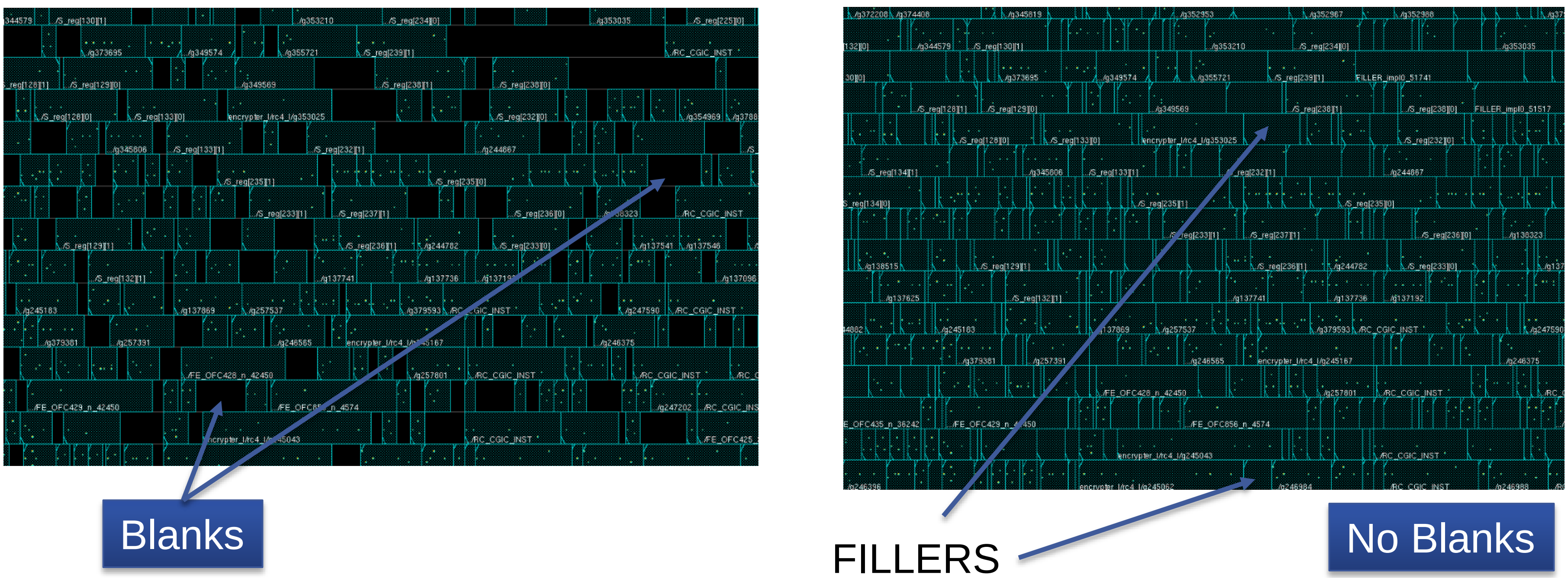
CTS: Report example




```
##################################################################
Path 1: VIOLATED Setup Check with Pin encrypter_I/rc4_I/K_reg[2]/CK
Endpoint:   encrypter_I/rc4_I/K_reg[2]/D (^) checked with  leading edge of 'clk'
Beginpoint: encrypter_I/rc4_I/i_reg[0]/Q (v) triggered by  leading edge of 'clk'
Path Groups: {reg2reg}
Analysis View: functional_worstHT
Other End Arrival Time          0.735
- Setup                         0.013
+ Phase Shift                   2.500
- Uncertainty                   0.150
= Required Time                 3.072
- Arrival Time                  3.303
= Slack Time                   -0.232
     Clock Rise Edge                      0.000
     = Beginpoint Arrival Time            0.000
     Timing Path:
     +-----------------------------------------------------------------------------------------------------
     |                   Pin                         | Edge |              Net
     |                                               |   |  |
     |-----------------------------------------------+------+----------------------------------------------
     | clk_in/DI                                     |  ^   | clk_int
     | clk_int__L1_I0/A                              |  ^   | clk_int
     | clk_int__L1_I0/Z                              |  ^   | clk_int__L1_N0
     | clk_int__L2_I0/A                              |  ^   | clk_int__L1_N0
     | clk_int__L2_I0/Z                              |  ^   | clk_int__L2_N0
     | clk_int__L3_I0/A                              |  ^   | clk_int__L2_N0
     | clk_int__L3_I0/Z                              |  ^   | clk_int__L3_N0
     | clk_int__L4_I3/A                              |  ^   | clk_int__L3_N0
     | clk_int__L4_I3/Z                              |  ^   | clk_int__L4_N3
     | encrypter_I/rc4_I/RC_CG_HIER_INST58/RC_CGIC_INST/C |  ^   | clk_int__L4_N3
     | K                                             |      |
     | encrypter_I/rc4_I/RC_CG_HIER_INST58/RC_CGIC_INST/G |  ^   | encrypter_I/rc4_I/rc_gclk_180681
     | CK                                            |      |
     | encrypter_I/rc4_I/i_reg[0]/CK                 |  ^   | encrypter_I/rc4_I/rc_gclk_180681
     | encrypter_I/rc4_I/i_reg[0]/Q                  |  v   | encrypter_I/rc4_I/n_31313
     | encrypter_I/rc4_I/FE_OCPC1786_n_31313/A       |  v   | encrypter_I/rc4_I/n_31313
     | encrypter_I/rc4_I/FE_OCPC1786_n_31313/Z       |  v   | encrypter_I/rc4_I/FE_OCPN1786_n_31313
     | encrypter_I/rc4_I/FE_OFC385_n_31313/A         |  v   | encrypter_I/rc4_I/FE_OCPN1786_n_31313
     | encrypter_I/rc4_I/FE_OFC385_n_31313/Z         |  v   | encrypter_I/rc4_I/FE_OFN385_n_31313
```

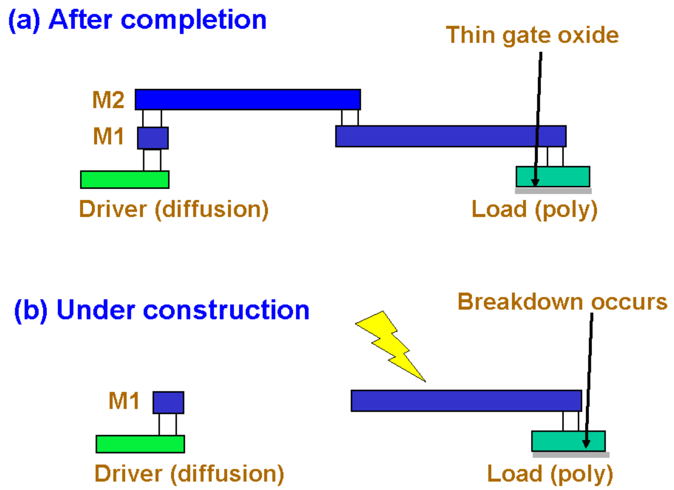
Routing: Global Overview

- Finish All data paths routing with accurate extraction
  - Fill the core area blanks with filler cells (see technology documentation for cell names)
  - Perform Global and detail routing
  - Extraction optimises RC and signal integrity quality



Routing: Antenna Fixing

- Antenna is a risk during manufacturing process
  - A discharge may occur through routed floating nets to transistor gates
  - IC would not be working if it happens
- Antenna Cells are inserted to ensure discharge occurs into substrate
- Routing might also leverage antenna fixing, so the router may route based on timing and Antenna constraints



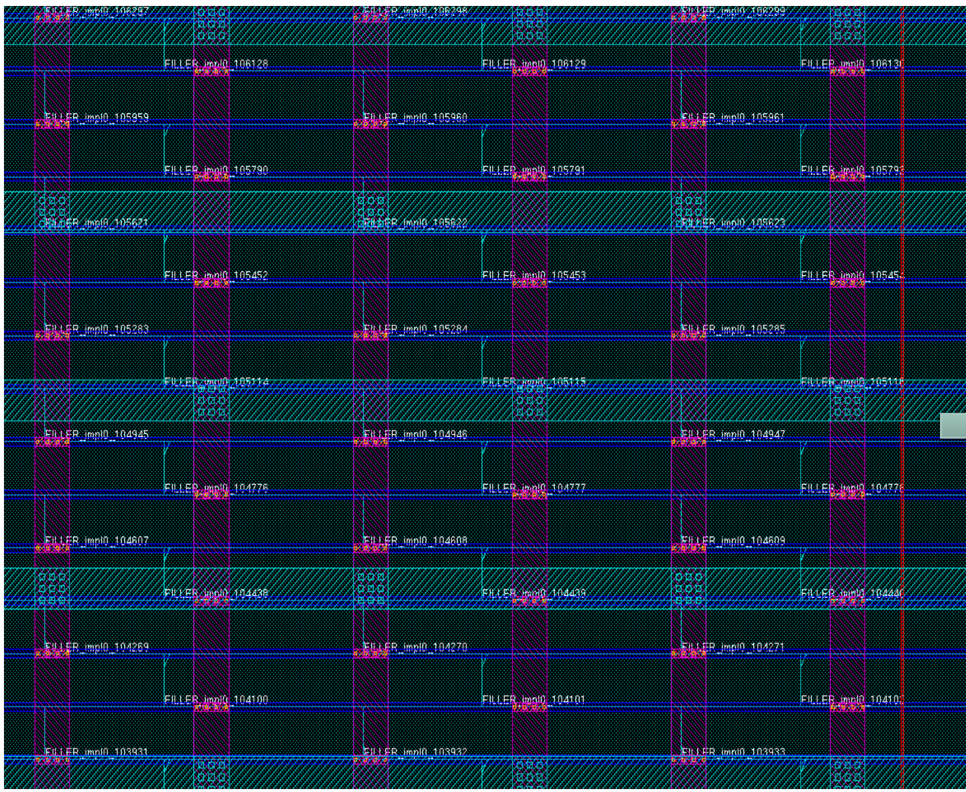
(wikipedia: Antenna Effect)

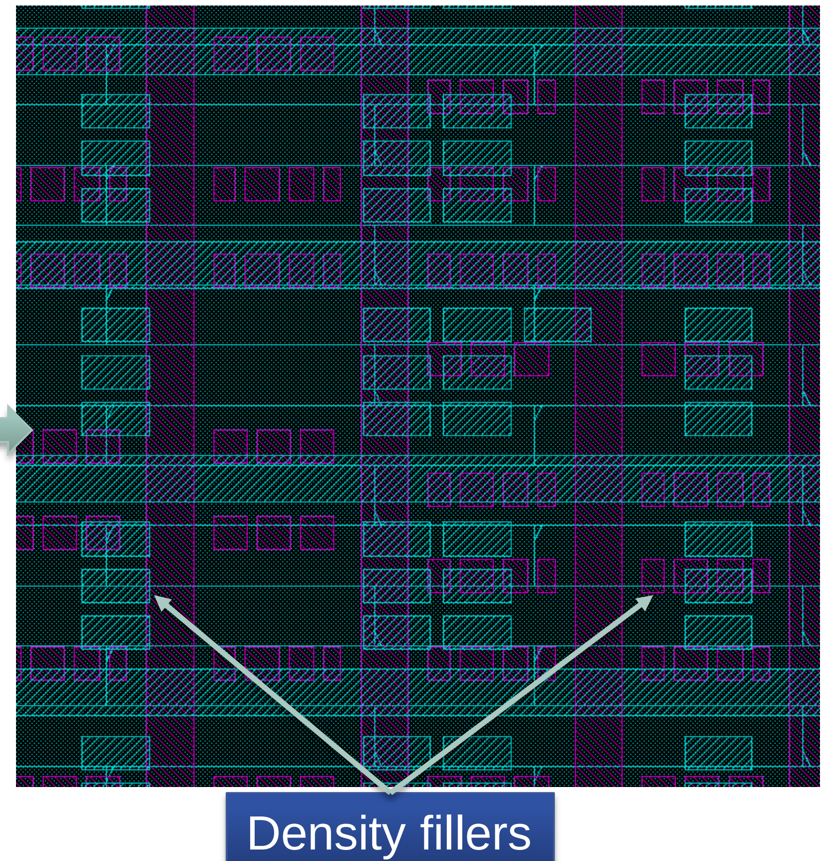
Prepare for Manufacturing

- Final Steps before manufacturing:
  - Verify and fix DRC
  - Retime/Refix design
- Perform Metal Filling to fix density DRC
  - Reverify/Retime/Refix design
- Write out a GDS file
- Perform Layout versus Schematic
  - Refix design
- Good to go!

Metal Filling

- Not always done in the tool, other tools can be used
- Sometimes the Foundry access service provider does metal filling (ex: Multi Project Wafer funs)





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